

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2999806

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KANAKO KOMATSU	08/20/2014
MARIKO SHIMIZU	08/20/2014
JUN MORIOKA	08/20/2014
KEITA TAKAHASHI	08/20/2014
MASAHITO NIGHIGOORI	08/20/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	KABUSHIKI KAISHA TOSHIBA
<b>Street Address:</b>	1-1, SHIBAURA 1-CHOME
<b>Internal Address:</b>	MINATO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14454555
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(212)319-5101
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2123194900
<b>Email:</b>	rlevinsohn@hhpatent.com
<b>Correspondent Name:</b>	HOLTZ, HOLTZ, GOODMAN & CHICK PC
<b>Address Line 1:</b>	220 FIFTH AVENUE
<b>Address Line 2:</b>	16TH FLOOR
<b>Address Line 4:</b>	NEW YORK, NEW YORK 10001
<b>ATTORNEY DOCKET NUMBER:</b>	13073CIP
<b>NAME OF SUBMITTER:</b>	RYAN LEVINSOHN
<b>SIGNATURE:</b>	/Ryan Levinsohn/
<b>DATE SIGNED:</b>	08/27/2014
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 5</b>	

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## Combined Declaration and Assignment

<b>Title of Invention</b>	<b>SEMICONDUCTOR DEVICE</b>	
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to:      <input type="checkbox"/> The attached application, or</p> <p style="padding-left: 150px;"><input checked="" type="checkbox"/> United States application or PCT International application number <u>14/454,555</u> filed on <u>August 7, 2014</u>.</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>In consideration of value received, I sell and assign to <u>KABUSHIKI KAISHA TOSHIBA</u>, having a business address at <u>1-1, Shibaura 1-chome, Minato-ku, Tokyo, JAPAN</u>, its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention, and in and to all applications for patent and patents for said invention, in all countries of the world, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of intellectual property, including rights of priority, resulting from the filing of any of said applications.</p> <p>I authorize said Assignee to file and prosecute an application or applications for patent for said invention as the applicant, and I request any official whose duty it is to issue patents, to issue any patent on said invention to said Assignee.</p> <p>I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention in all countries.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p>		
<b>LEGAL NAME OF INVENTOR</b>		
Kanako KOMATSU	<i>Kanako Komatsu</i>	Aug. 20, 2014.
Inventor (printed name)	Signature	Date

**Holtz, Holtz, Goodman & Chick PC**  
 220 Fifth Avenue, 16th Floor, New York, NY 10001-7708  
 Tel. (212) 319-4900    Fax. (212) 319-5101

## Combined Declaration and Assignment

**Title of  
Invention**

**SEMICONDUCTOR DEVICE**

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This declaration  
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☐ The attached application, or

☒ United States application or PCT international application  
number 14/454,555 filed on August 7, 2014.

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to all applications for patent and patents for said invention, in all countries of the world, including all  
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### LEGAL NAME OF INVENTOR

Mariko SHIMIZU

*Mariko Shimizu*

*Aug. 20, 2014*

Inventor (printed name)

Signature

Date

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### LEGAL NAME OF INVENTOR

Jun MORIOKA

*Jun Morioka*

*Aug. 20, 2014*

Inventor (printed name)

Signature

Date

**Holtz, Holtz, Goodman & Chick PC**  
220 Fifth Avenue, 16th Floor, New York, NY 10001-7708  
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**PATENT**

**REEL: 033623 FRAME: 0303**

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#### LEGAL NAME OF INVENTOR

Keita TAKAHASHI

Keita Takahashi

Aug. 20. 2014

Inventor (printed name)

Signature

Date

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## LEGAL NAME OF INVENTOR

Masahito NISHIGOORI

*Masahito Nishigoori*

*Aug. 20, 2014*

Inventor (printed name)

Signature

Date

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PATENT

REEL: 033623 FRAME: 0305

RECORDED: 08/27/2014